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SPECIFICATION

CUSTOMER :

MODULE NO.:

WH1602B-TFH-CT#

APPROVED BY:

(FOR CUSTOMER USE ONLY)

PCB VERSION:

DATA:

SALES BY	APPROVED BY	CHECKED BY	PREPARED BY

VERSION	DATE	REVISED PAGE NO.	SUMMARY
0	2008/8/26		First issue

	nstar Displa 凌光電股份有限		D MODLE NO :
REC	ORDS OF REV	ISION	DOC. FIRST ISSUE
VERSION	DATE	REVISED PAGE NO.	SUMMARY
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1.Module Classification Information

$\underline{W} \underline{H} \quad \underline{1} \underbrace{6} \underbrace{0} \underbrace{2} \quad \underline{B} - \underline{T} \underline{F} \underline{H} - \underline{CT} \#$

02 3 4 5 6 7 8

^① Brand: WINSTAR DISPLAY CORPORATION

⁽²⁾ Display Type : $H \rightarrow$ Character Type, $G \rightarrow$ Graphic Type

- ⁽³⁾ Display Font : Character 16 words, 2Lines.
- Model serials no.

5	Backlight Type :	$N \rightarrow$ Without backlight	A→ LED, Amber				
		$B \rightarrow EL$, Blue green	$R \rightarrow LED$, Red				
		D→ EL, Green	O→ LED, Orange				
		$W \rightarrow EL$, White	$G \rightarrow LED$, Green				
		$F \rightarrow CCFL$, White	$T \rightarrow LED$, White				
		$Y \rightarrow$ LED, Yellow Green					
6	LCD Mode :	B→ TN Positive, Gray	T→ FSTN Negative				
		$N \rightarrow TN$ Negative,					
		$G \rightarrow STN$ Positive, Gray					
		$Y \rightarrow STN$ Positive, Yellow Green					
		$M \rightarrow STN$ Negative, Blue					
		F→ FSTN Positive					
7	LCD Polarize Type/ Temperature	$A \rightarrow Reflective, N.T, 6:00$	H→ Transflective, W.T,6:00				
	range/ View	$D \rightarrow Reflective, N.T, 12:00$	K→ Transflective, W.T,12:00				
	direction	$G \rightarrow$ Reflective, W. T, 6:00	$C \rightarrow$ Transmissive, N.T,6:00				
		$J \rightarrow$ Reflective, W. T, 12:00	$F \rightarrow$ Transmissive, N.T, 12:00				
		$B \rightarrow$ Transflective, N.T,6:00	I→ Transmissive, W. T, 6:00				
		$E \rightarrow$ Transflective, N.T.12:00	$L \rightarrow$ Transmissive, W.T, 12:00				
8	Special Code	CT : English and Cyrillic stand #:Fit in with the ROHS Direction					

2.Precautions in use of LCD Modules

- (1)Avoid applying excessive shocks to the module or making any alterations or modifications to it.
- (2)Don't make extra holes on the printed circuit board, modify its shape or change the components of
 - LCD module.
- (3)Don't disassemble the LCM.
- (4)Don't operate it above the absolute maximum rating.
- (5)Don't drop, bend or twist LCM.
- (6)Soldering: only to the I/O terminals.
- (7)Storage: please storage in anti-static electricity container and clean environment.
- (8)Winstar have the right to change the passive components
- (9)Winstar have the right to change the PCB Rev

3.General Specification

Item	Dimension	Unit				
Number of Characters	16 characters x 2 Lines	-				
Module dimension	80.0 x 36.0 x 13.5(MAX)	mm				
View area	66.0 x 16.0	mm				
Active area	56.20 x 11.5	mm				
Dot size	0.55 x 0.65	mm				
Dot pitch	0.60 x 0.70	mm				
Character size	2.95 x 5.55	mm				
Character pitch	3.55 x 5.95	mm				
LCD type	FSTN Positive Transflective, (In LCD production, It will occur slightly color difference. We can only guarantee the same color in the same batch.)					
Duty	1/16					
View direction	6 o'clock					
Backlight Type	LED white					

4.Absolute Maximum Ratings

Item	Symbol	Min	Тур	Max	Unit
Operating Temperature	T _{OP}	-20	-	+70	°C
Storage Temperature	T _{ST}	-30	-	+80	°C
Input Voltage	VI	V _{SS}	-	V _{DD}	V
Supply Voltage For Logic	VDD-V _{SS}	-0.3	-	7	V
Supply Voltage For LCD	V_{DD} - V_0	-0.3	-	13	V

5.Electrical Characteristics

Item	Symbol	Condition	Min	Тур	Max	Unit
Supply Voltage For Logic	V _{DD} -V _{SS}	-	4.5	5.0	5.5	V
		Ta=-20°C	-	-	5.2	v
Supply Voltage For LCD *Note	V_{DD} - V_0	Ta=25°C	-	3.7	-	V
		Ta=70°C	3.2	-	-	V
Input High Volt.	V _{IH}	-	$0.7 V_{DD}$	-	V _{DD}	V
Input Low Volt.	V _{IL}	-	Vss	-	0.6	V
Output High Volt.	V _{OH}	-	3.9	-	V _{DD}	V
Output Low Volt.	V _{OL}	-	-	-	0.4	V
Supply Current	I _{DD}	V _{DD} =5V	1.0	1.2	1.5	mA

* Note: Please design the VOP adjustment circuit on customer's main board



6.Optical Characteristics

Item	Symbol	Condition	Min	Тур	Max	Unit
View Angle	(V)θ	CR≧ 5	30	-	60	deg
	(H) φ	CR≧ 5	-45	-	45	deg
Contrast Ratio	CR	-	-	5	-	-
Response Time	T rise	-	-	150	200	ms
	T fall	-	-	150	200	ms

Definition of Operation Voltage (Vop)

Definition of Response Time (Tr , Tf)





Conditions :

Operating Voltage : Vop

Viewing Angle(θ , ϕ) : 0° , 0°

Driving Waveform : 1/N duty, 1/a bias

Frame Frequency : 64 HZ

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Definition of viewing angle($CR \ge 2$)



7.Interface Pin Function

Pin No.	Symbol	Level	Description
1	V _{SS}	0V	Ground
2	V _{DD}	5.0V	Supply Voltage for logic
3	VO	(Variable)	Operating voltage for LCD
4	RS	H/L	H: DATA, L: Instruction code
5	R/W	H/L	H: Read(MPU→ Module) L: Write(MPU→ Module)
6	Е	H,H→ L	Chip enable signal
7	DB0	H/L	Data bus line
8	DB1	H/L	Data bus line
9	DB2	H/L	Data bus line
10	DB3	H/L	Data bus line
11	DB4	H/L	Data bus line
12	DB5	H/L	Data bus line
13	DB6	H/L	Data bus line
14	DB7	H/L	Data bus line
15	А	-	LED +
16	К	-	LED -

8.Contour Drawing & Block Diagram



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9.Function Description

The LCD display Module is built in a LSI controller, the controller has two 8-bit registers, an instruction register (IR) and a data register (DR).

The IR stores instruction codes, such as display clear and cursor shift, and address information for display data RAM (DDRAM) and character generator (CGRAM). The IR can only be written from the MPU. The DR temporarily stores data to be written or read from DDRAM or CGRAM. When address information is written into the IR, then data is stored into the DR from DDRAM or CGRAM. By the register selector (RS) signal, these two registers can be selected.

RS	R/W	Operation
0	0	IR write as an internal operation (display clear, etc.)
0	1	Read busy flag (DB7) and address counter (DB0 to DB7)
1	0	Write data to DDRAM or CGRAM (DR to DDRAM or CGRAM)
1	1	Read data from DDRAM or CGRAM (DDRAM or CGRAM to DR)

Busy Flag (BF)

When the busy flag is 1, the controller LSI is in the internal operation mode, and the next instruction will not be accepted. When RS=0 and R/W=1, the busy flag is output to DB7. The next instruction must be written after ensuring that the busy flag is 0.

Address Counter (AC)

The address counter (AC) assigns addresses to both DDRAM and CGRAM

Display Data RAM (DDRAM)

This DDRAM is used to store the display data represented in 8-bit character codes. Its extended

capacity is 80×8 bits or 80 characters. Below figure is the relationships between DDRAM addresses



and positions on the liquid crystal display.

Display position DDRAM address

1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16
00	01	02	03	04	05	06	07	08	09	0A	0B	0C	0D	0E	0F
40	41	42	43	44	45	46	47	48	49	4A	4B	4C	4D	4E	4F
2-Line by 16-Character Display															

Character Generator ROM (CGROM)

The CGROM generate 5×8 dot or 5×10 dot character patterns from 8-bit character codes. See Table 2.

Character Generator RAM (CGRAM)

In CGRAM, the user can rewrite character by program. For 5×8 dots, eight character patterns can be

written, and for 5×10 dots, four character patterns can be written.

Write into DDRAM the character code at the addresses shown as the left column of table 1. To show the character patterns stored in CGRAM.

Relationship between CGRAM Addresses, Character Codes (DDRAM) and Character patterns

Table 1.

For 5 * 8 dot character patterns

Character Codes (DDRAM data)	CGRAM Address	Character Patterns (CGRAM data)	
7 6 5 4 3 2 1 0	5 4 3 2 1 0	7 6 5 4 3 2 1 0	
High Low	High Low	High Low	-
0 0 0 0 * 0 0 0	$\begin{array}{cccccccccccccccccccccccccccccccccccc$	* * * * 0 0 0 * * * 0 0 0 0 * * * 0 0 0 0 * * * 0 0 0 0 * * * 0 0 0 0 * * * 0 0 0 0 * * * 0 0 0 0 * * * 0 0 0 0 * * * 0 0 0 0 * * * 0 0 0 0 * * * 0 0 0 0	Character pattern(1) Cursor pattern
0 0 0 0 * 0 0 1	$\begin{array}{cccccccccccccccccccccccccccccccccccc$	* * * 0 0 0 * * * 0 0 0 0 * * * * * * * * * * * • • • * * * * • • • * * * • • • • • * * * 0 0 0 0 • • * * * • • • • • • * * * • • • • • • * * * •	Character pattern(2) Cursor pattern
	0 0 1		
0 0 0 0 * 1 1 1	$\begin{array}{cccccccccccccccccccccccccccccccccccc$	* * *	
For 5 * 10 dot character patter	n c		
Character Codes (DDRAM data)	CGRAM Address	Character Patterns (CGRAM data)	
7 6 5 4 3 2 1 0	5 4 3 2 1 0	7 6 5 4 3 2 1 0	
High Low	High Low	High Low	
0 0 0 0 * 0 0 0	$\left \begin{array}{cccccccccccccccccccccccccccccccccccc$	* * * 0 0 0 0 * * * 0 0 0 0 * * * 0 0 0 0 * * * 0 0 0 0 * * * 0 0 0 0 * * * 0 0 0 0 * * * 0 0 0 0 * * * 0 0 0 0 * * * 0 0 0 0 * * * 0 0 0 0 * * * 0 0 0 0 * * * 0 0 0 0	Character pattern Cursor pattern
		* * * * * * *	

🔳 : " High "

10.Character Generator ROM Pattern

Upper 4 bit Lower 4 bit	LLLL	LLLH	LLHL	LLHH	LHLL	LHLH	LHHL	LHHH	HLLL	HLLH	HLHL	HLHH	HHLL	HHLH	HHHL	нннн
LLLL	CG RAM (1)					 :	••	.					•]	:		
LLLH	CG RAM (2)		-											I		
LLHL	CG RAM (3)		::					!					1			
LLHH	CG RAM (4)					:	:							::		.
LHLL	CG RAM (5)							•					.			
LHLH	CG RAM (6)			•••••			:::::	II								
LHHL	CG RAM (7)					l.,.!		ŧ.,.ŧ					ŀ			
LHHH	CG RAM (8)		-				•	II					•;;;;		•*	
HLLL	CG RAM (1)						!	:-::				!	-::-:			
HLLH	CG RAM (2)					ار ا ا		•					:-]:-			
HLHL	CG RAM (3)		:-[-:	:: ::								Þ:	:: ::	••		
HLHH	CG RAM (4)		[::							•	.]]]	:• :•	ŀ	•	•
HHLL	CG RAM (5)		:=	•••••								[]		•		
HHLH	CG RAM (6)						[**]					.	÷	ŀ		
HHHL	CG RAM (7)				ŀ	••••	!·":	- <u>-</u>								
нннн	CG RAM (8)		[*]	•			::							==	::	

11.Instruction Table

.				Ins	structi	ion Co	de					Execution time
Instruction	RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Description	(fosc=270Khz)
Clear Display	0	0	0	0	0	0	0	0	0	1	Write "00H" to DDRAM and set DDRAM address to "00H" from AC	1.53ms
Return Home	0	0	0	0	0	0	0	0	1	-	Set DDRAM address to "00H" from AC and return cursor to its original position if shifted. The contents of DDRAM are not changed.	1.53ms
Entry Mode Set	0	0	0	0	0	0	0	1	I/D	SH	Assign cursor moving direction and enable the shift of entire display.	39µ s
Display ON/OFF Control	0	0	0	0	0	0	1	D	С	В	Set display (D), cursor (C), and blinking of cursor (B) on/off control bit.	39µ s
Cursor or Display Shift	0	0	0	0	0	1	S/C	R/L	-	-	Set cursor moving and display shift control bit, and the direction, without changing of DDRAM data.	39µ s
Function Set	0	0	0	0	1	DL	N	F	-	-	Set interface data length (DL:8-bit/4-bit), numbers of display line (N:2-line/1-line)and, display font type (F:5×11 dots/5×8 dots)	39µ s
Set CGRAM Address	0	0	0	1	AC5	AC4	AC3	AC2	AC1	AC0	Set CGRAM address in address counter.	39µ s
Set DDRAM Address	0	0	1	AC6	AC5	AC4	AC3	AC2	AC1	AC0	Set DDRAM address in address counter.	39µ s
Read Busy Flag and Address	0	1	BF	AC6	AC5	AC4	AC3	AC2	AC1	AC0	Whether during internal operation or not can be known by reading BF. The contents of address counter can also be read.	0µ s
Write Data to RAM	1	0	D7	D6	D5	D4	D3	D2	D1	D0	Write data into internal RAM (DDRAM/CGRAM).	43µ s
Read Data from RAM	1	1	D7	D6	D5	D4	D3	D2	D1	D0	Read data from internal RAM (DDRAM/CGRAM).	43µ s

* " - " : don't care

12. Timing Characteristics

12.1 Write Operation

• Writing data from MPU



Ta=25°C, VDD=5.0V

Item	Symbol	Min	Тур	Max	Unit
Enable cycle time	T _C	1200	-	-	ns
Enable pulse width	T _{PW}	140	-	-	ns
Enable rise/fall time	T _R ,T _F	_	-	25	ns
Address set-up time (RS, R/W to E)	t _{AS}	0	-	-	ns
Address hold time	t _{AH}	10	-	-	ns
Data set-up time	t _{DSW}	40	-	-	ns
Data hold time	t _H	10	-	-	ns

12.2 Read Operation

• Reading data from ST7066U



Ta=25°C, VDD=5V

Item	Symbol	Min	Тур	Max	Unit
Enable cycle time	T _C	1200	-	-	ns
Enable pulse width (high level)	T _{PW}	140	-	-	ns
Enable rise/fall time	T _R ,T _F	-	-	25	ns
Address set-up time (RS, R/W to E)	t _{AS}	0	-	-	ns
Address hold time	t _{AH}	10	-	-	ns
Data delay time	t _{DDR}	-	-	100	ns
Data hold time	t _H	10	-	-	ns

13.Initializing of LCM



4-Bit Ineterface



8-Bit Ineterface

14.Reliability

	Environmental Test		
Test Item	Content of Test	Test Condition	Note
High Temperature storage	Endurance test applying the high storage temperature for a long time.	80°C 200hrs	2
Low Temperature storage	Endurance test applying the high storage temperature for a long time.	-30°C 200hrs	1,2
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	70°C 200hrs	
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	-20°C 200hrs	1
High Temperature/ Humidity Operation	The module should be allowed to stand at 60 °C,90%RH max For 96hrs under no-load condition excluding the polarizer, Then taking it out and drying it at normal temperature.	60°C,90%RH 96hrs	1,2
Thermal shock resistance	The sample should be allowed stand the following 10 cycles of operation -20°C 25°C 70°C 30_{-1} cycle	-20°C/70°C 10 cycles	
Vibration test	Endurance test applying the vibration during transportation and using.	Total fixed amplitude : 1.5mm Vibration Frequency : 10~55Hz One cycle 60 seconds to 3 directions of X,Y,Z for Each 15 minutes	3
Static electricity test	Endurance test applying the electric stress to the terminal.	VS=800V,RS=1.5k Ω CS=100pF 1 time	

Content of Reliability Test (wide temperature, -20°C~70°C)

Note1: No dew condensation to be observed.

Note2: The function test shall be conducted after 4 hours storage at the normal

Temperature and humidity after remove from the test chamber.

Note3: Vibration test will be conducted to the product itself without putting it in a container.

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15.Backlight Information

PARAMETER	SYMBOL	MIN	ТҮР	MAX	UNIT	TEST CONDITION
Supply Current	ILED	28.8	32	40	mA	V=3.5V
Supply Voltage	V	3.4	3.5	3.6	V	-
Reverse Voltage	VR	-	-	5	V	-
Luminous Intensity	IV	245.6	307	-	CD/M ²	ILED=32mA
Chromaticity	x	-	0.300	-	-	-
	У	-	0.310	-	-	-
Life Time (For Reference	-	_	30K	-	Hr.	ILED≦ 32mA 25°C,50-60%RH,
only)						(Note 1)
Color	White					

Specification

Note: The LED of B/L is drive by current only, drive voltage is for reference only. drive voltage can make driving current under safety area (current between minimum and maximum).

Note 1:The brightness will decrease to 50% of the original value after 30K hours

2.Drive from pin15,pin16



ill never get Vee output from pin15)

16. Inspection specification

NO	Item			Criterion		AQL	
01	Electrical Testing	 1.1 Missing vertical, horizontal segment, segment contrast defect. 1.2 Missing character, dot or icon. 1.3 Display malfunction. 1.4 No function or no display. 1.5 Current consumption exceeds product specifications. 1.6 LCD viewing angle defect. 1.7 Mixed product types. 1.8 Contrast defect. 					
02	Black or white spots on LCD (display only)	three white o 2.2 Densely space	r black spo ed: No mo	bre than two spots o		2.5	
03	LCD black spots, white spots, contamination (non-display)	3.1 Round type : Φ =(x + y) X 4 3.2 Line type : (4)	/ 2 • •	SIZE $\Phi \le 0.10$ 0.10 < $\Phi \le 0.20$ 0.20 < $\Phi \le 0.25$ $0.25 < \Phi$	Acceptable Q TY Accept no dense 2 1 1 0	2.5	
		\rightarrow L $\stackrel{\text{w}}{\underset{\text{L}}{\overset{\text{w}}{\overset{w}}{\overset{w}}{\overset{w}}{\overset{w}}{\overset{w}}}}}}}}$	Length L≦ 3.0 L≦ 2.5 	Width W \leq 0.02 0.02 < W \leq 0.03 0.03 < W \leq 0.05 0.05 < W	Acceptable Q TY Accept no dense 2 As round type	2.5	

04	Polarizer bubbles	If bubbles are visible, judge using black spot specifications, not easy to find, must check in specify direction.	Size Φ $\Phi \le 0.20$ $0.20 < \Phi \le 0.50$ $0.50 < \Phi \le 1.00$ $1.00 < \Phi$	Acceptable Q TY Accept no dense 3 2 0	2.5
			Total Q TY	3	

NO	Item	Criterion	AQL
05	Scratches	Follow NO.3 LCD black spots, white spots, contamination	



NO Item Criterion AQ



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NO	Item	Criterion	AQL
07	Cracked glass	The LCD with extensive crack is not acceptable.	2.5
08	Backlight elements	 8.1 Illumination source flickers when lit. 8.2 Spots or scratched that appear when lit must be judged. Using LCD spot, lines and contamination standards. 8.3 Backlight doesn' t light or color wrong. 	0.65 2.5 0.65
09	Bezel	9.1 Bezel may not have rust, be deformed or have fingerprints, stains or other contamination.9.2 Bezel must comply with job specifications.	2.5 0.65
10	РСВ、СОВ	 10.1 COB seal may not have pinholes larger than 0.2mm or contamination. 10.2 COB seal surface may not have pinholes through to the IC. 10.3 The height of the COB should not exceed the height indicated in the assembly diagram. 10.4 There may not be more than 2mm of sealant outside the seal area on the PCB. And there should be no more than three places. 10.5 No oxidation or contamination PCB terminals. 10.6 Parts on PCB must be the same as on the production characteristic chart. There should be no wrong parts, missing parts or excess parts. 10.7 The jumper on the PCB should conform to the product characteristic chart. 10.8 If solder gets on bezel tab pads, LED pad, zebra pad or screw hold pad, make sure it is smoothed down. 10.9 The Scraping testing standard for Copper Coating of PCB 	 2.5 2.5 0.65 2.5 0.65 0.65 2.5 2.5 2.5 2.5
11	Soldering	11.1 No un-melted solder paste may be present on the PCB.	2.5 2.5

 11.2 No cold solder joints, missing solder connect oxidation or icicle. 11.3 No residue or solder balls on PCB. 11.4 No short circuits in components on PCB. 	ons, 2.5 0.65
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17. Material List of Components for

<u>RoHs</u>

1. WINSTAR Display Co., Ltd hereby declares that all of or part of products (with the mark "#"in code), including, but not limited to, the LCM, accessories or packages, manufactured and/or delivered to your company (including your subsidiaries and affiliated company) directly or indirectly by our company (including our subsidiaries or affiliated companies) do not intentionally contain any of the substances listed in all applicable EU directives and regulations, including the following substances.

Exhibit A: The Harmful Material List

Material	(Cd)	(Pb)	(Hg)	(Cr6+)	PBBs	PBDEs
Limited Value	100 ppm	1000 ppm	1000 ppm	1000 ppm	1000 ppm	1000 ppm
Above limit	ed value is s	et up accord	ing to RoHS	•	1	

2.Process for RoHS requirement :

(1) Use the Sn/Ag/Cu soldering surface ; the surface of Pb-free solder is rougher than we used before.

(2) Heat-resistance temp. :

Reflow: 250, 30 seconds Max.;

Connector soldering wave or hand soldering : 320 , 10 seconds max.

(3) Temp. curve of reflow, max. Temp. : 235 ± 5 ;

Recommended customer's soldering temp. of connector : 280 , 3 seconds.

winstar LCM Sample Estimate Feedback Sheet

	winstar	LCM Sample	e .		<u>e reeu</u>	раск	Sheet
Module	e Number:						Page: 1
1、 <u>P</u>	anel Specificat	tion :					
1.	Panel Type :		I	Pass		NG	,
2.	View Directio	n: 🗆	I	Pass		NG	,
3.	Numbers of D	ots:	I	Pass		NG	,
4.	View Area:		I	Pass		NG	,
5.	Active Area :		I	Pass		NG	,
6.	Operating Ter	nperature : 🗆	I	Pass		NG	,
7.	Storage Temp	erature : 🗆	I	Pass		NG	,
8.	Others :						
2、 <u>M</u>	lechanical Spe	cification :					
1.	PCB Size :		I	Pass		NG	,
2.	Frame Size :		I	Pass		NG	,
3.	Materal of Fra	ame : 🗆	I	Pass		NG	,
4.	Connector Pos	sition :	I	Pass		NG	,
5.	Fix Hole Posi	tion :	I	Pass		NG	,
6.	Backlight Pos	ition :	I	Pass		NG	,
7.	Thickness of l	PCB:	I	Pass		NG	,
8.	Height of Fran	me to PCB : \Box	I	Pass		NG	,
9.	Height of Mo	dule : 🗆	I	Pass		NG	,
10.	Others :		I	Pass		NG	,
3、 <u>R</u>	elative Hole Si	ize :					
1.	Pitch of Conne	ector :	I	Pass		NG	,
2.	Hole size of C	onnector :	I	Pass		NG	,
3.	Mounting Hol	e size :	I	Pass		NG	,
4.	Mounting Hol	e Type :	I	Pass			2
5.	Others :		I	Pass			,
4、 <u>B</u>	acklight Speci	fication :					
1.]	B/L Type :		I	Pass		NG ,	
2.]	B/L Color:		I	Pass		NG ,	
3.]	B/L Driving Vo	ltage (Reference	e f	for LED T	Sype) :		Pass D NG ,
4.]	B/L Driving Cu	irrent :	I	Pass		NG <u>,</u>	
5.]	Brightness of E	S/L: □	I	Pass			
6.]	B/L Solder Met	thod :	I	Pass			
7	Others :		I	Pass			

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Module Number :

5、 <u>Electronic Characteristics of Module</u> :

- 1. Input Voltage : □ Pass 2. Supply Current : □ Pass 3. Driving Voltage for LCD : □ Pass 4. Contrast for LCD : □ Pass 5. B/L Driving Method : \square Pass 6. Negative Voltage Output : □ Pass 7. Interface Function : □ Pass 8. LCD Uniformity : □ Pass 9. ESD test : □ Pass 10. Others : \square Pass
- 6, <u>Summary</u>:



Sales signature :

Customer Signature : _____

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